#### TOSHIBA THYRISTOR SILICON PLANAR TYPE

# **USF05G49**

## LOW POWER SWITCHING AND CONTROL APPLICATIONS

 Repetitive Peak Off-State Voltage : VDRM = 400 V Repetitive Peak Reverse Voltage : VRRM = 400 V
 Average On-State Current : IT (AV) = 500 mA

### **MAXIMUM RATINGS**

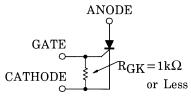
CHARACTERISTIC	SYMBOL	RATING	UNIT	
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	V <sub>DRM</sub> V <sub>RRM</sub>	400	V	
Non-Repetitive Peak Reverse Voltage (Non-Repetitive<5ms, $T_j = 0\sim125^{\circ}C$ )	V <sub>RSM</sub>	500	>	
Average On-State Current (Half Sine Waveform)	I <sub>T (AV)</sub>	500	mA	
R.M.S On-State Current	I <sub>T (RMS)</sub>	800	mA	
Peak One Cycle Surge On-State Current (Non-Repetitive)	I <sub>TSM</sub>	9 (50Hz)	А	
		10 (60Hz)		
I <sup>2</sup> t Limit Value	1 <sup>2</sup> t	0.4	A <sup>2</sup> s	
Critical Rate of Rise of On-State Current (Note 1)	di / dt	10	A / µs	
Peak Gate Power Dissipation	$P_{GM}$	0.1	V	
Average Gate Power Dissipation	P <sub>G(AV)</sub>	0.01	W	
Peak Forward Gate Voltage	$V_{FGM}$	3.5	V	
Peak Reverse Gate Voltage	$V_{RGM}$	-5	V	
Peak Forward Gate Current	I <sub>GM</sub>	125	mA	
Junction Temperature	Tj	-40~125	°C	
Storage Temperature Range	T <sub>stg</sub>	-40~125	°C	

Note 1: di / dt Test condition:  $i_G = 5mA$ ,  $t_{gw} = 10\mu s$ ,  $t_{gr} \le 250ns$ 

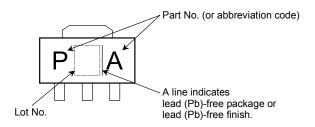
### Unit: mm 1.6MAX. 4.6MAX 1.7MAX. 0.4 ± 0.05 4.2MAX. +0.08 0.45 - 0.05 +0.08 0.4 - 0.05 $1.5 \pm 0.1$ 1.5 ± 0.1 1. GATE ANODE CATHODE **JEDEC** JEITA **TOSHIBA** 13-5B1A

Weight: 0.2 g (typ.)

Note: Should be used with gate resistance as shown below.



### **MARKING**

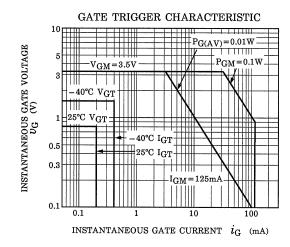


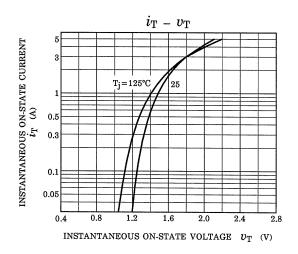


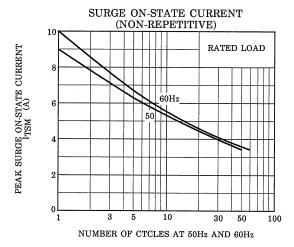
## ELECTRICAL CHARACTERISTICS (Ta = 25°C)

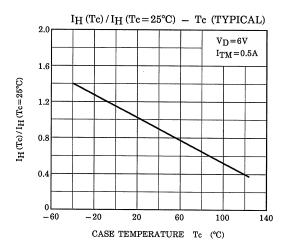
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current	I <sub>DRM</sub> I <sub>RRM</sub>	V <sub>DRM</sub> = V <sub>RRM</sub> = Rated	_	_	10	μΑ
Peak On-State Voltage	V <sub>TM</sub>	I <sub>TM</sub> = 1A	_	_	1.5	V
Gate Trigger Voltage	V <sub>GT</sub>	$V_D = 6V, R_L = 100\Omega$	_	_	0.8	V
Gate Trigger Current	I <sub>GT</sub>	$R_{GK} = 1k\Omega$	_	_	200	μA
Holding Current	lн	$I_{TM}$ = 500mA, $V_D$ = 6V R <sub>GK</sub> = 1k $\Omega$	-	-	6	mA
Critical Rate of Rise of Off-State Voltage	d <sub>V</sub> / dt	$V_{DRM}$ = Rated, $R_{GK}$ = 1kΩ Exponential Rise	_	200	_	V / µs
Gate Turn-On Time	t <sub>gt</sub>	$V_D$ = Rated, $i_G$ = 5mA R <sub>GK</sub> = 1k $\Omega$	_	_	1.5	μs
Thermal Resistance	R <sub>th(j−a)</sub>	Junction to Ambient	_	_	70	°C/W

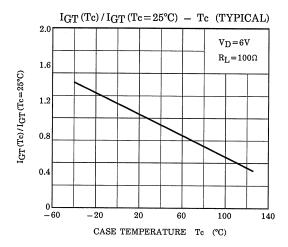
Note: Thermal Resistance Test Condition Use 0.6×30×30mm Alumina Plate

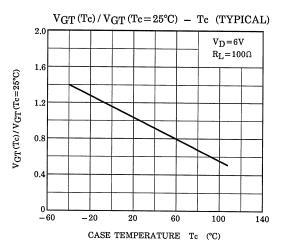


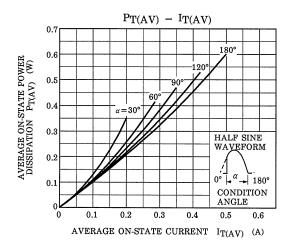


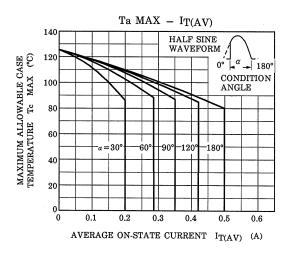


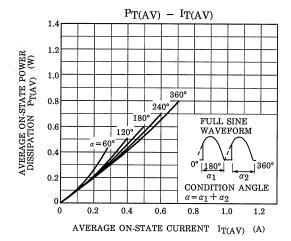


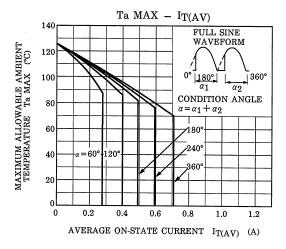


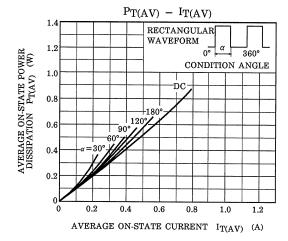


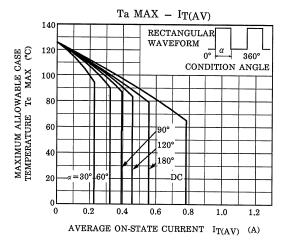


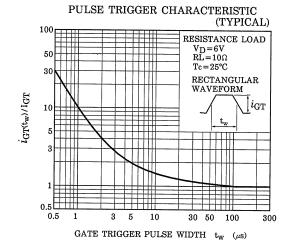


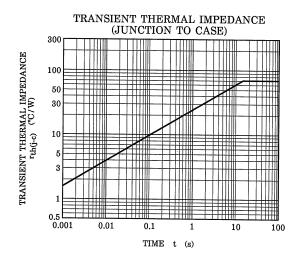












### **RESTRICTIONS ON PRODUCT USE**

030619EAA

- The information contained herein is subject to change without notice.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of TOSHIBA or others.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
  In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- TOSHIBA products should not be embedded to the downstream products which are prohibited to be produced and sold, under any law and regulations.